



Taiwan 3DS-IC Committee Meeting Summary and Minutes

Taiwan 3DS-IC TC Meeting November 22, 2013,14:00-15:30 SEMI Taiwan, HsinChu

Next Committee Meeting March, 2014 3DS-IC TC Meeting, SEMI Taiwan, HsinChu

Committee Announcements (optional)

Table 1 Meeting Attendees :

Co-Chairs: Dr. TK Ku (ITRI)/Wendy Chen(KYEC) **SEMI Staff:** Cher Wu

Company	Last	First	Company	Last	First
KYEC	Chen	Wendy	KYEC	MingChin	Tsai
ITRI	Ku	T. K.	ITRI	Ku	Yi-Sha
ITRI-CMS	Yao	Bin-Cheng	ITRI	Lee	Heng-Li
CMPUG TW	Kong	L. C.	NTUST/CIC	Hsu	Pei-Chun
ITRI	Chen	Erh-Hao			

Table 2 Leadership Changes :

None

Table 3 Ballot Results (or move to Section 4, Ballot Review)

Passed ballots and line items will be submitted to the ISC Audit & Review Subcommittee for procedural review. None

Table 4 Authorized Ballots (or move to Section 7, New Business)

None.

Table 5 Authorized Activities (or move to Section 7, New Business)

SNARF#	Staus	SC/TF/WG	Details
5688		Middle-End Process TF	Guideline for bonding overlay target design and measurement





Table 6 New Action Items (or move to Section 8, Action Item Review)

- 6.1 NAASE Representative
- 6.2 Study new topic of Die Sort, look for manufacturers to join
- 6.3 Check with SEMI Japan to open the teleconference tool for 3DSIC TC meeting during SEMICON Japan 2013
- 6.4 SEMI staff to plan the 3DS IC promotion activity in 2014 to draw more intention

6.5 SEMI staff to follow up with ASE to assign the co-chair representative by Dec. 15

Table 7 Previous Meeting Actions Items (or move to Section 8, Action item Review)

7.1 Co-chair, ASE Representative Status.

1 Welcome, Reminders, and Introductions

Mr. TK Ku(ITRI) called the meeting to order at 14:00. The meeting reminders on antitrust issues, intellectual property issues and holding meetings with international attendance were reviewed. Attendees introduced themselves.

Review of Previous Meeting Minutes

The committee reviewed the minutes of the previous meeting.

Attachment: 3DS-IC Meeting Minutes 20130730

3. Staff Report

- SEMI October 2013 Standards Liaison Report
- Dec, 17, 2013 Standards Annual Gathering and Award Ceremony

4. Liaison Reports

- SEMI Staff Report: --NA/Japan Liaison Report
- Attachment: SEMI Global 3DS-IC report October 2013

5. Ballot Review

None

6. Old Business

7. New Business

- · Middle-end TF submit the SNARF: Guideline for bonding overlay target design and measurement
- Motion/2nd: TK Ku(ITRI) / LC Kong (CMPUG)
- Discussion: Will revise the words and direction with quality control criteria.
- Vote: 7-0-0 in favor Motion passed

SNARF#	Staus	SC/TF/WG	Details
5688		Middle-End Process TF	Guideline for bonding overlay target design and measurement





8. Action Item Review

- · Check ASE, co-chair's continuity and representative
- Invite MTI/PTI to join
- · Invite local equipment makers to study new topic of Die Sort
- 3DSIC promotion plan on SEMICON Taiwan 2014 to draw Taiwan local equipment makers' awareness.
- SEMICON Japan 3DSIC meeting will ask Dr. Arthur Chen to join if he is available. Meanwhile, check

with SEMI Japan about the teleconference call tool

• Go to meeting function open to next TC meeting

9. Next Meeting and Adjournment

March, 2014 Respectfully submitted by: Cher Wu SEMI Taiwan Phone:+ 886 3 560 1777 +802 Email: <u>cwu@semi.org</u>

Minutes approved by:

T. K. Ku (ITRI), Co-Chair <a>Chai <date approved=""> December 14 ,2013</date>
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Table 8 Index of Available Attachments #1

#	Title	#	Title
1	20131122 3DSIC TC Meeting Minutes	3	
2	2013 Global 3DSIC TC Liaison Report		

#1 Due to file size and delivery issues, attachments must be downloaded separately. A .zip file containing all attachments for these minutes is available at www.semi.org. For additional information or to obtain individual attachments, please contact [SEMI Staff Name] at the contact information above.





Respectfully submitted by: Catherine Chang Sr. Manager SEMI Taiwan Phone: 03-573 3399 # 217 Email: cchang@semi.org

Minutes approved by:	
TK Ku/ITRI, Co-Chair	<date approved=""> 6 June, 2012</date>

Table 9 Index of Available Attachments #1

#	Title	#	Title
1	Required Elements 2011		
2	3DS-IC Meeting Minutes 20120209		
3	NA 3DS-IC report April 2012		
	SNARF_Middle-end process Doc.2		
	SNARF_Middle-end process		

#2 Due to file size and delivery issues, attachments must be downloaded separately. A .zip file containing all attachments for these minutes is available at www.semi.org. For additional information or to obtain individual attachments, please contact [SEMI Staff Name] at the contact information above.